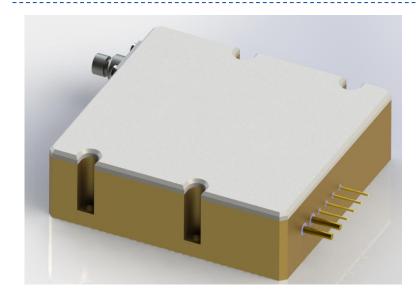


976nm 200W High Power Detachable Diode Laser

RPK976-200.0W-40022-SM (Customized Product)



Features:

- 976nm wavelength
- 200W output power
- 400µm fiber core diameter
- 0.22NA
- 1040nm~1200nm feedback protection

Applications:

- Material Processing
- 3D Printing

High Power Diode Laser Modules are manufactured by adopting specialized fiber-coupling techniques, resulting in volume products with a high efficiency, stability and superior beam quality. The products are achieved by transforming the asymmetric radiation from the laser diode chip into an output fiber with small core diameter by using special micro optics. Inspecting and burn-in procedures in every aspect come to a result to guarantee each product with the reliability, stability and long lifetime.

Our research staffs are constantly improving and innovating the processing technology in the producing process, based on the professional knowledge and experience accumulated in long-terms. We are also continuously developing new products to meet customers' specific needs.

High quality products with reasonable price is our always goal.



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Specifications(25℃)	Symbol	Unit	RPK976-200.0W-40022-SM		
			Minimum	Typical	Maximum
CW-Output Power	Po	W	200	-	-
Center Wavelength	λο	nm	976±10		
Spectral Width (FWHM)	Δλ	nm	-	< 5	-
Wavelength Shift with Temperature	∆λ/△Τ	nm/℃	-	0.3	-
Wavelength Shift with Current	Δλ/ΔΑ	nm/A	-	1	-
Electrical-to-Optical Efficiency	PE	%	-	45	-
Operating Current	lop	Α	-	13.5	14
Threshold Current	Ith	Α	-	0.9	-
Operating Voltage	V _{op}	V	-	-	37.5
Slope Efficiency	η	W/A	-	17	-
Core Diameter	D _{core}	μm	-	400	-
Numerical Aperture	NA	-	-	0.22	-
Connector	-	-	-	SMA905	-
Wavelength Range	λ	nm	1040~1200		
Isolation	-	dB	-	30	-
ESD	V _{esd}	V	-	-	500
Storage Temperature (2)	T _{st}	°C	-20	-	70
Lead Soldering Temp	T _{Is}	°C	-	-	260
Lead Soldering Time	t	sec	-	-	10
Operating Case Temperature ⁽³⁾	Тор	°C	20	-	30
Relative Humidity	RH	%	15	-	75
Output Power	Pa	mW	-	2	-
Wavelength	la	nm	635±10		
Voltage	Va	V	-	2.2	-
'					1
	CW-Output Power Center Wavelength Spectral Width (FWHM) Wavelength Shift with Temperature Wavelength Shift with Current Electrical-to-Optical Efficiency Operating Current Threshold Current Operating Voltage Slope Efficiency Core Diameter Numerical Aperture Connector Wavelength Range Isolation ESD Storage Temperature (2) Lead Soldering Temp Lead Soldering Time Operating Case Temperature(3) Relative Humidity Output Power Wavelength	CW-Output Power P_o Center Wavelength λ_c Spectral Width (FWHM) $\Delta\lambda$ Wavelength Shift with Temperature $\Delta\lambda/\Delta T$ Wavelength Shift with Current $\Delta\lambda/\Delta A$ Electrical-to-Optical EfficiencyPEOperating Current I_{op} Threshold Current I_{th} Operating Voltage V_{op} Slope Efficiency η Core Diameter D_{core} Numerical ApertureNAConnector-Wavelength Range λ Isolation-ESD V_{esd} Storage Temperature (2) T_{st} Lead Soldering Temp T_{ls} Lead Soldering Time t Operating Case Temperature (3) T_{op} Relative Humidity RH Output Power P_a Wavelength I_a	CW-Output Power Po W Center Wavelength λc nm Spectral Width (FWHM) Δλ nm Wavelength Shift with Temperature Δλ/ΔΤ nm/°C Wavelength Shift with Current Δλ/ΔΑ nm/A Electrical-to-Optical Efficiency PE % Operating Current Iop A Threshold Current Ith A Operating Voltage Vop V Slope Efficiency η W/A Core Diameter Dcore μm Numerical Aperture NA - Connector - - Wavelength Range λ nm Isolation - dB ESD Vesd V Storage Temperature (2) Tst °C Lead Soldering Temp Tis °C Lead Soldering Time t sec Operating Case Temperature (3) Top °C Relative Humidity RH % Output Power Pa mW Wavelength Ia	CW-Output Power P₀ W 200	CW-Output Power P₀ W 200 Center Wavelength λ₀ nm 976±10

⁽¹⁾ Data measured under operation output at 200W@25°C.

⁽²⁾ A non-condensing environment is required for operation and storage.

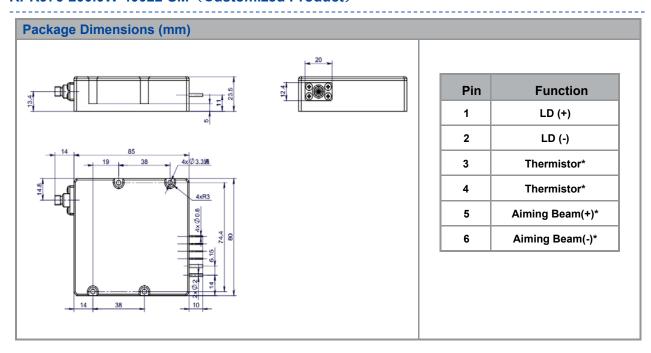
⁽³⁾ Operating temperature defined by the package housing. Acceptable operating range is 20°C~30°C, but performance may vary.





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OPERATING NOTES

- ◆ Avoid eye and skin exposure to direct radiation during operation.
- ♦ ESD precautions must be taken during storage, transportation and operation.
- ♦ Short-circuit is required between pins during storage and transportation.
- Please connect pins to wires by solder instead of using socket when operation current is higher than 6A. Soldering point should be close to the root of the pins. Soldering temperature should be lower than 260°C and time shorter than 10 second.
- ◆ Make sure the fiber output end is properly cleaned before operation of laser. Follow safety protocols to avoid injury when handling and cutting the fiber.
- ♦ Use constant current power supply to avoid surge current during operation.
- ◆ Laser diode must be used according to the specifications.
- Laser diode must work with good cooling.
- ◆ Operation temperature ranges from 20°C to 30°C.
- \blacklozenge Storage temperature ranges from -20°C to +70°C .

